

Technical Data Sheet

	Product Name:	3MM Blue light em	nitting diode
	Part Number:	KGK-204SUBC-F	H40-A3(F)
	Customer:	3MM 白发蓝	
	Customer PN:		
	Version:	A.2	
	Date:	2015-10-16	
	Custo	mer Appro	oval
Instituted By:	Check	ed By:	Approved By:



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Features

• Package (L/W/H): 3 mm

• Color: Ultra Bright Standard Blue

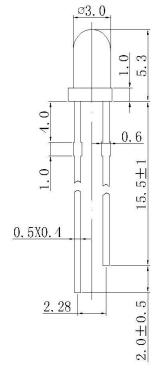
• Lens: Transparent colloid

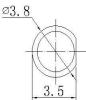
EIA STD Package

• Meet ROHS, Green Product

Package Profile & Soldering PAD Suggested

Package Profile:







Notes: 1. All dimensions are in millimeters;

2. Tolerance is \pm 0.10 mm unless otherwise noted.

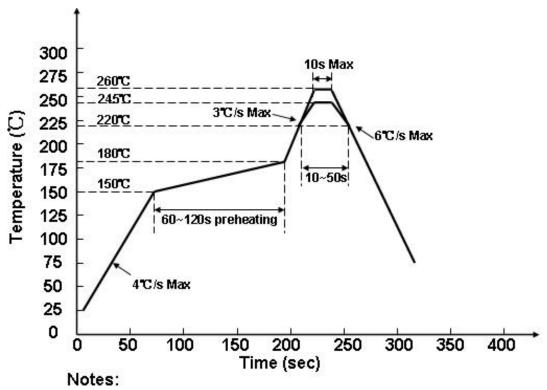


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Soldering Profile Suggested

Wave soldering:



We recommend the soldering temperature 245±5℃; The maximum temperature should be limited to 260 ℃.

- 1: soldering temperature: the temperature is about 350 DEG C, the welding time is about 2S
- 2: Solderability Test conditions: temperature of about 240~250 C / C, test time is 5S, test requirements after testing normal electrical performance, appearance no adverse.



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Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	75	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	100	mA
DC Forward Current	IF	20	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-30°C ∼ +85°C	
Storage Temperature Range	Tstg	-40°C ~ +90°C	
Soldering Condition	Tsol	Hand soldering: 300 °C For 3 Second	
ESD CLASS	ESD	2000	V



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General Characteristics

Bin Range of Luminous Intensity

Bin	Min	Max	Unit	Condition
T2	800	1500		
U1	1500	2300	mcd	IF=20mA
U2	2300	3000		

Notes: Tolerance of Luminous Intensity: ± 11%

Bin Range of Wavelength

Bin	Min	Max	Unit	Condition
A	460	465		IE-20 A
В	465	470	nm	IF=20mA

Notes: Tolerance of Wavelength: ± 1nm

Bin Range of Forward Voltage

Bin	Min	Max	Unit	Condition	
7	2.8	3.0			
8	3.0	3.2	1	IE-20 A	
9	3.2	3.4	V	IF=20mA	
Н	3.4	3.6			

Notes: Tolerance of Forward Voltage: $\pm 0.02V$



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Typical Electrical-Optical Characteristics Curves

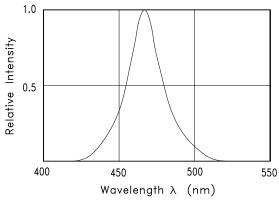
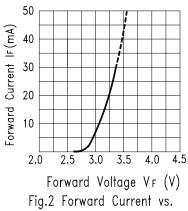


Fig1. RELATIVE INTENSITY VS. WAVELENGTH



Forward Voltage

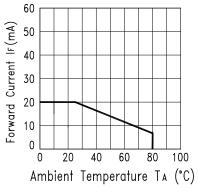


Fig.3 Forward Current Derating Curve

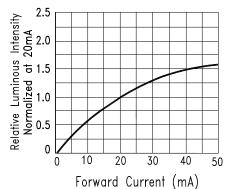


Fig.4 Relative Luminous Intensity vs. Forward Current

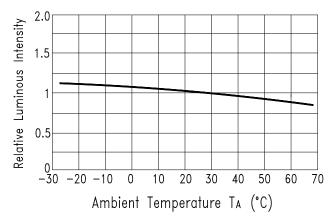


Fig.5 Luminous Intensity vs.Ambient Temperature

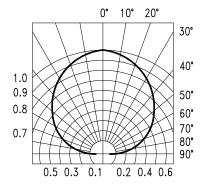


Fig.6 Spatial Distribution



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Label Explanation

CAT: Luminous Intensity Rank (unit: mcd)

HUE: CIE 1931 Coordinate Rank

REF: Forward Voltage Rank (unit: V)

Rank Tolerance:

a. Luminous Intensity: ± 11%

b. HUE: ±0.005

c. Forward Voltage: $\pm 0.02V$

Reliability Test

Classification	Test Item	Test Condition	Reference Standard	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating	1000HRS (-24HRS,+72HRS)*@20mA	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
Endurance Test	High Temperature, High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 85±5℃,RH= 85%	1000HRS±2HRS	JESD22-A101
Test	High Temperature Storage	Ta= 105±5°C	1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5°C	1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12
	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
Environmental Test	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}\text{C} \sim -40^{\circ}\text{C} \pm 5^{\circ}\text{C}$ 10mins 10mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	Solder Resistance	T.sol= 260 ± 5 °C	10 ± 1secs	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1



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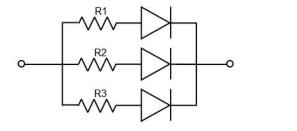
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IR-Reflow	Ramp-up rate(183°C to Peak) +3°C/ second max Temp. maintain at 125(±25)°C 120 seconds max Temp. maintain above 183°C 60-150 seconds Peak temperature range 235°C+5/-0°C		MIL-STD-750D:2031.2 J-STD-020C
Normal Process	Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max		
IR-Reflow Pb Free Process	Ramp-up rate(217°C to Peak) +3°C/ second max Temp. maintain at 175(±25)°C 180 seconds max Temp. maintain above 217°C 60-150 seconds Peak temperature range 260°C+0/-5°C Time within 5°C of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
Solderability	T.sol= 235 ± 5 °C Immersion rate 25 ± 2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	Immersion time 2±0.5 sec	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

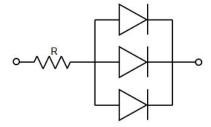
Cautions

Application

- 1. A LED is a current-operated device. The slight shift of voltage will cause big change of current, which will damage LEDs. Customer should use resistors in series for the Over-Current-Proof.
- 2. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below. The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.







Circuit model B

3. High temperature may reduce LEDs' intensity and other performances, so keeping it away from heat source to get good performance is necessary.

Storage

1.Before opening original package, it is recommended to store them in the following environment:



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Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$; Humidity: 85%RH max.When the inventory over 2 months,Should be done before treatment using dehumidification, Temperature: $60^{\circ}\text{C}/8$ hours.

- 2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity.
- 3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
- 4. The LEDs should be used within 48hrs (2 days) after opening the package. Once been mounted, soldering should be quick.
- 5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 48hrs (2 days), baking treatment should be performed using the conditions: 60°C at least 24 hours.

ESD (Electrostatic Discharge)-Protection

A LED (especially the Blue \ White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light-up" at low currents, etc. Some advice as below should be noticed:

- 1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs.
- 2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded.
- 3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.
- 4. Use ionizer to neutralize the static charge during handling or operating.
- 5. All surfaces and objects within 1 ft close to LEDs measure less than 100V.

Cleaning

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary.

Soldering

- 1. Soldering condition refer to the draft "Soldering Profile Suggested" on page 1.
- 2. Reflow soldering should not be done more than 2 times.
- 3. Manual soldering is only suggested on repair and rework. The maximum soldering temperature should not exceed 300°C within 3 sec. And the maximum capacity of soldering iron is 30W in power.
- 4. During the soldering process, do not touch the lens at high temperature.
- 5. After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.

Others

1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office



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equipment, communication equipment and household applications). Consult Harvatek's Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

- 2. The light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.
- 3. The appearance and specifications of the product may be modified for improvement without prior notice.
- 4. LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating.